

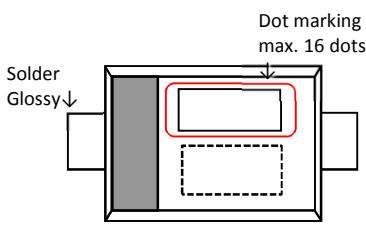
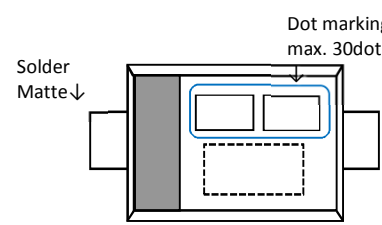
ROHM Co., Ltd  
 Diode div.  
 Masatoshi SHIMOJIMA, General Manager

## Product Change Notification

**Content: Change for the purpose of better traceability and better solderability**

Please reply by 20 / Nov. /2016 by filling in the boxes below.

No feedback by this date is regarded as acceptance of the change.

Application: PMDU package series, Diodes			
Contents of change		Current	After change (additional spec)
	(P/N) Example	RB160M-60TR	RB160M <b>M</b> -60TR
	1. Mold compound	Bromine-based flame retardant epoxy resin (Flame retardant grade: UL94 V-0) No change for products using Halogen free resin currently, e.g. TFZG series	Halogen free flame retardant epoxy resin (Flame retardant grade: UL94 V-0)
	2. Solder composition	Sn-3Ag-0.5Cu (Printing melted solder) Solder surface: Glossy	Sn (Electro plating) Solder surface: Matte
	3. Making (Dot mark)	Discernible manufactured date with 16dots	Discernible complete production lot code with 30dots
	Ref: External view	 <p style="text-align: center;">(Current)</p>	 <p style="text-align: center;">(After change)</p>
Others	Nothing changed for the die inside of package nor electrical characteristics Nothing inferior for performance nor reliability to current products		
Reasons of change	1. Shift to environmental friendly halogen-free resin 2. Improvement of solderability with pure-tin plating on pins 3. Perfect traceability with high density 30 dots marking on package		
Term of change	After your approval, we will supply both type of products in parallel.		
Attachment	Nothing		

## Form of reply

To: ROHM Co., Ltd.

Diode Div.

Customer Name \_\_\_\_\_

Result	1. Approved
	2. Approved with some condition
	3. Rejected
	(Condition or reason rejected)

Date: \_\_\_\_\_